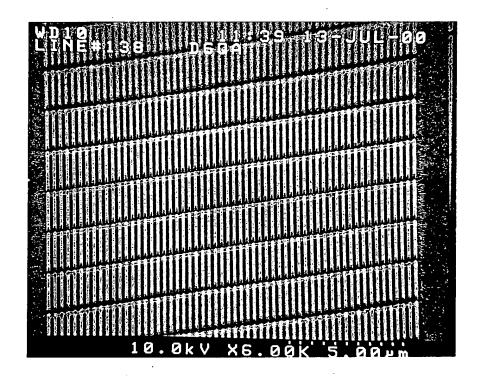


FIG.1A



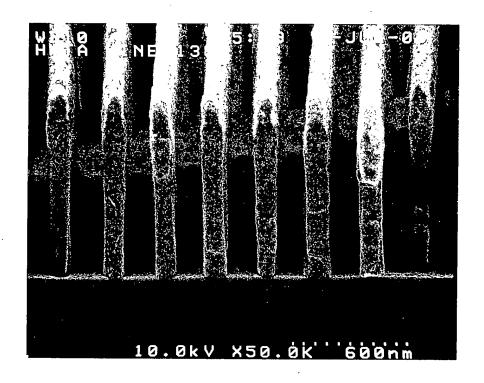


FIG. 2A







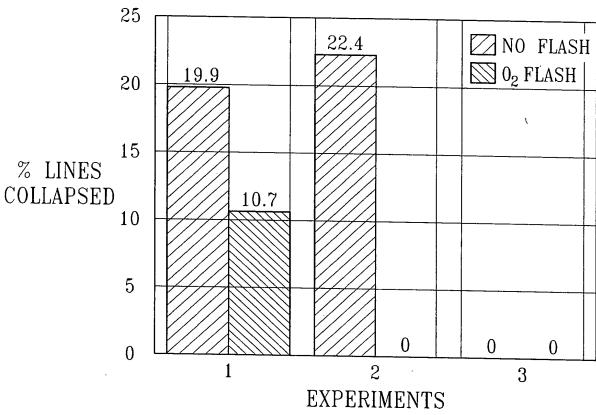


FIG.3



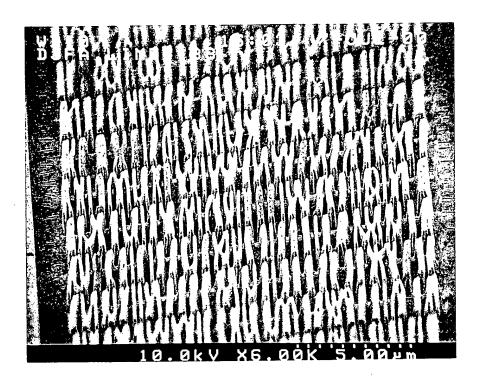
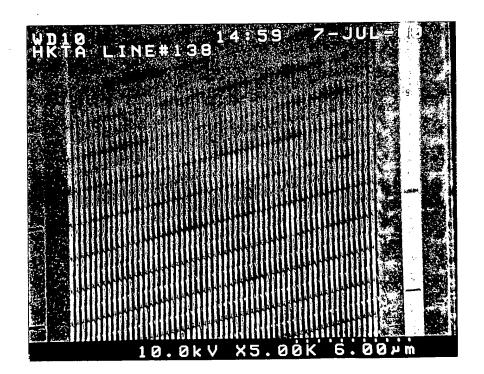


FIG.4A





Docket No.: 20140-00272-US

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TC 17011

(PATENT)

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

#3

In re Patent Application of:

Arpan P. Mahorowala

Application No.: 09/902,728

Filed: July 12, 2001

For: METHOD TO PREVENT PATTERN COLLAPSE IN FEATURES ETCHED IN

SULFER DIOXIDE-CONTAINING PLASMAS

Conf. No.: 9522

Group Art Unit: N/A

Examiner: Not Yet Assigned

SUBMISSION OF FORMAL DRAWINGS

Commissioner for Patents Washington, DC 20231

Dear Sir:

Applicants submit herewith 4 sheets of formal drawings of Figs. 1A-1B, 2A-2B, 3 and 4A-4B.

Dated: October 18, 2002

Respectfully submitted,

John A. Evans

By

Registration No.: 44,100

CONNOLLY BOVE LODGE & HUTZ, LLP

1990 M Street, N.W., Suite 800 Washington, DC 20036-3425

(202) 331-7111

(202) 293-6229 (Fax)

Attorneys for Applicant